1. Part No. Expression

<u>SMF100512R07KZF</u>

- (a)
- (b)
- (c) (d) (e) (f)
- (a) Series Code

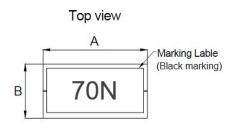
- (d) Tolerance Code
- (b) Dimension Code

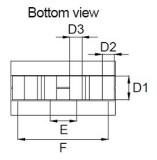
(e) Special Code

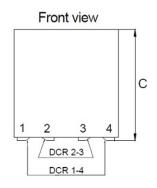
(c) Inductance Code

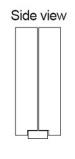
(f) Packaging Code

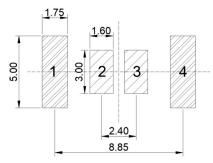
2. Configuration & Dimensions (Unit: mm)









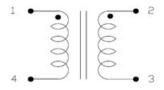


Recommended PCB Layout

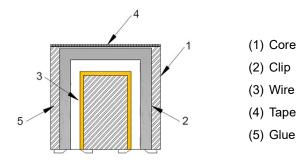
Note: 1. Marking: Inductance (Please refer to Electrical Characteristics table)

| Α | В | С | D1 | D2 | D3 | E | F |
|-----------|----------|-----------|----------|----------|----------|----------|----------|
| 10.00 Max | 5.00 Max | 12.00 Max | 2.30 Typ | 1.10 Typ | 0.86 Typ | 1.96 Typ | 8.60 Typ |

3. Schematic



4. Material List



5. General Specifications

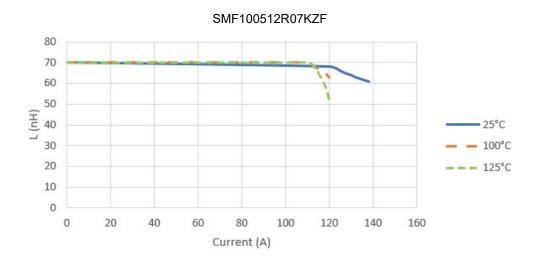
- (a) Operating Temp.: -40°C to +125°C (including self-temperature rise)
- (b) Storage Temp.: -40°C to +125°C (on board)
- (c) All test data referenced to 25°C ambient.
- (d) Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C.
- (e) Saturation Current (Isat 1) will cause inductance L0 to drop approximately 20% at +25°C.
- (f) Saturation Current (Isat 2) will cause inductance L0 to drop approximately 20% at +100°C.
- (g) Saturation Current (Isat 3) will cause inductance L0 to drop approximately 20% at +125°C.
- (h) Rated Current: The lower value of Isat and Irms.
- (i) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

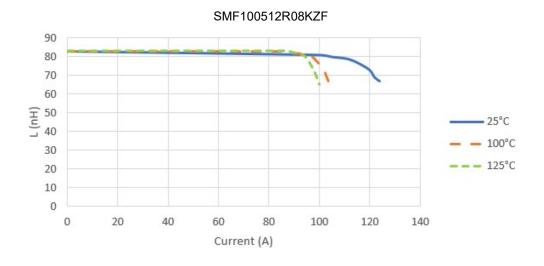
6. Electrical Characteristics

| Part Number | Inductance (nH) @0A 1-4/2-3 ±10% | Inductance (nH) @Isat1 1-4 Min | (m | CR Ω) 0% | Isat 1 (A) | Isat 2 (A) | Isat 3 (A) | | ns A) 2-3 | Marking |
|-----------------|-------------------------------------------|-----------------------------------------|-------|----------------|---------------|---------------|---------------|----|-----------------|---------|
| SMF100512R07KZF | 70 | 50 | 0.125 | 0.450 | 127 | 110 | 100 | 75 | 35 | 70N |
| SMF100512R08KZF | 80 | 57 | 0.125 | 0.450 | 111 | 96 | 87 | 75 | 35 | 80N |
| SMF100512R09KZF | 90 | 64 | 0.125 | 0.450 | 98 | 85 | 77 | 75 | 35 | 90N |
| SMF100512R10KZF | 100 | 72 | 0.125 | 0.450 | 89 | 77 | 70 | 75 | 35 | R10 |
| SMF100512R12KZF | 120 | 86 | 0.125 | 0.450 | 74 | 64 | 58 | 75 | 35 | R12 |
| SMF100512R15KZF | 150 | 108 | 0.125 | 0.450 | 59 | 51 | 46 | 75 | 35 | R15 |
| SMF100512R17KZF | 170 | 122 | 0.125 | 0.450 | 52 | 45 | 41 | 75 | 35 | R17 |

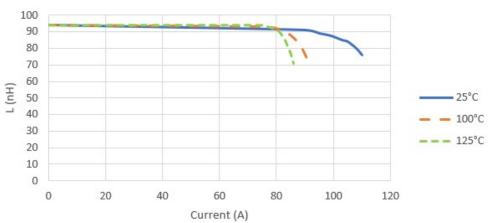
Test Frequency: 1.0V/100kHz

7. Characteristics Curve

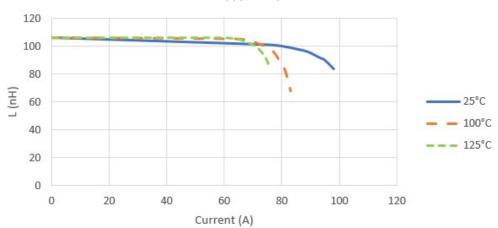


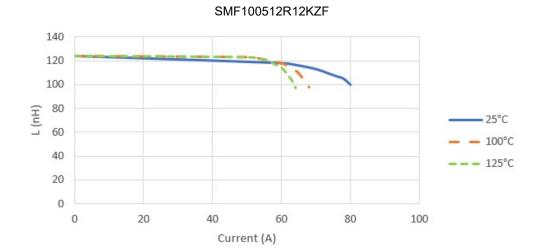


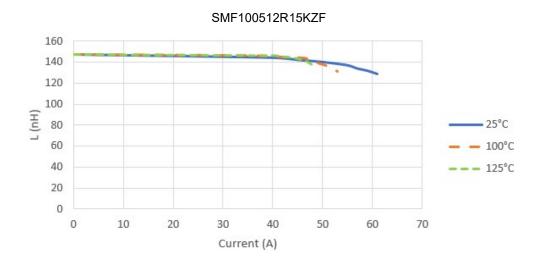
SMF100512R09KZF

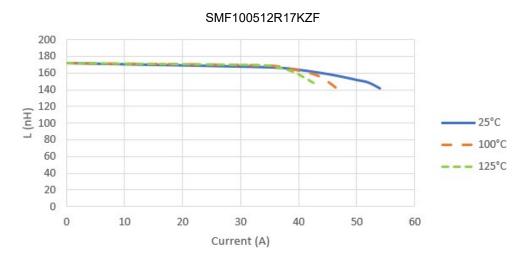


SMF100512R10KZF









8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

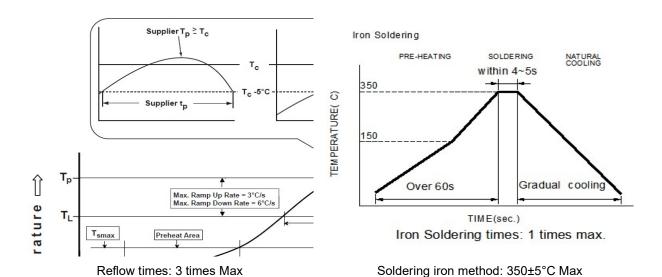
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

Note:

- (a) Preheat circuit and products to 150°C.
- (b) 355°C tip temperature (Max.)
- (c) Never contact the ceramic with the iron tip
- (d) 1.0mm tip diameter (Max.)

Figure 1: IR Soldering Reflow

- (e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- (f) Limit soldering time to 4~5 sec.



NOTE: Specifications subject to change without notice. Please check our website for latest information.

Figure 2: Iron soldering temperature profiles

Table (1.1) Reflow Profiles

| Profile Type: | Pb-Free Assembly |
|----------------------------------------------------------------------------|------------------|
| Preheat | |
| -Temperature Min (T _{smin}) | 150°C |
| -Temperature Max (T _{smax}) | 200°C |
| -Time (t _s) from (T _{smin} to T _{smax}) | 60-120seconds |
| Ramp-up rate (T _L to T _p) | 3°C /second max. |
| Liquids temperature (T _L) | 217°C |
| Time (t∟) maintained above T∟ | 60-150 seconds |
| Classification temperature (T _c) | See Table (1.2) |
| Time (t _p) at Tc- 5°C (Tp should be equal to or less than Tc.) | *< 30 seconds |
| Ramp-down rate (T _P to T _L) | 6°C /second max. |
| Time 25°C to peak temperature | 8 minutes max. |

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc**.

Table (1.2) Package Thickness/Volume and Classification Temperature (Tc)

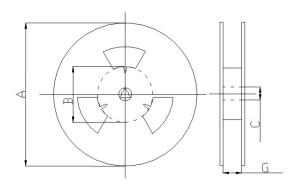
| | Package | Volume mm ³ | Volume mm ³ | Volume |
|----------|-----------|------------------------|------------------------|-----------|
| | Thickness | <350 | 350-2000 | mm³ >2000 |
| PB-Free | <1.6mm | 260°C | 260°C | 260°C |
| | 1.6-2.5mm | 260°C | 250°C | 245°C |
| Assembly | ≥2.5mm | 250°C | 245°C | 245°C |

Reflow is referred to standard IPC/JEDEC J-STD-020E.

^{*}Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

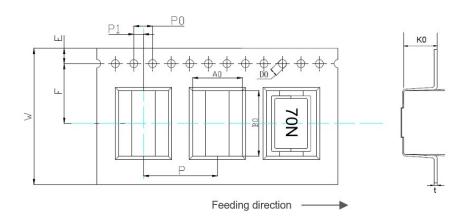
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



| Туре | А | В | С | G |
|------------|-------|-------|------|------|
| 13" x 24mm | 330.0 | 100.0 | 13.5 | 24.5 |

9-2. Tape Dimension (Unit: mm)

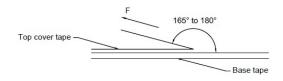


| В0 | A0 | K0 | Р | P0 | P1 |
|------------|------------|------------|------------|-----------|-----------|
| 10.20±0.10 | 5.20±0.10 | 12.20±0.10 | 16.00±0.10 | 4.00±0.10 | 2.00±0.10 |
| W | F | E | D0 | t | - |
| 24.00±0.30 | 11.50±0.10 | 1.75±0.10 | 1.50±0.10 | 0.40±0.05 | - |

9-3. Packaging Quantity (Unit: Pcs)

| 300 |
|-----|
| |

9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

| Room Temp. (°C) | Room Humidity (%) | Room atm (hPa) | Tearing Speed (mm/min) |
|-----------------------|-------------------------|-------------------|------------------------------|
| 5~35 | 45~85 | 860~1060 | 300±10 |

| Tape Size | 8 mm | 12 to 56 mm | 72 mm or Wider |
|---------------------------------|--------|-------------|----------------|
| Tearing Off Force (grams) | 10~100 | 10~130 | 10~150 |

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.